

fig.26

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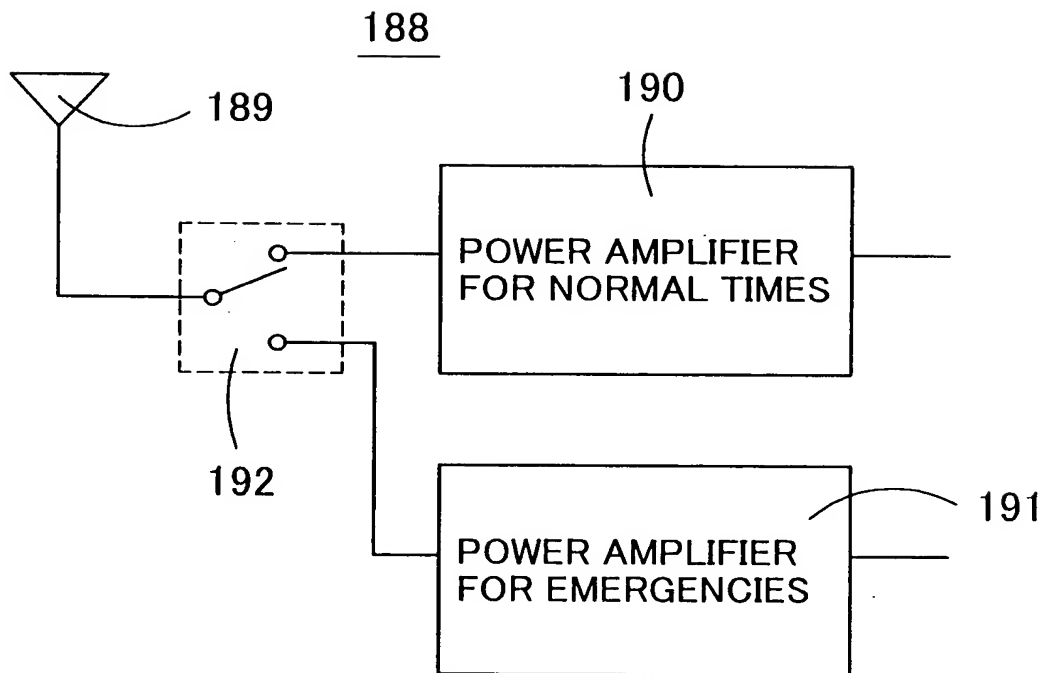


fig.27

Table of Reference Numbers

20	a stationary substrate
21	a silicon substrate
22	a fixed electrode
23, 24	signal lines
23A, 24A	fixed contacts
26, 27, 28, 29	through holes
30, 31	wiring conductors
32, 33, 34, 35	connection bumps
40	a movable substrate
42A, 42B	resilient bending portions
43	a movable electrode
45A, 45B	resilient supporting portions
46	a movable contact portion
50	a cap
52	a gap sealing portion
53, 54	fixed contact sealing portions
69	a ground line for high frequency
120	a stationary substrate
122	a fixed electrode
123, 124	signal lines
136, 137	fixed contacts
126, 127, 128, 129	through grooves
132, 133, 134, 135	connection bumps
136, 137	fixed contacts
140	a movable substrate
143	a movable electrode
146	a movable contact portion
148	a movable contact
150	a cap
152	a gap sealing portion